

**AMENDMENT TRANSMITTAL LETTER**Docket No.  
M4065.0135/P135Serial No.  
09/285,668Filing Date  
April 5, 1999Examiner  
T. QuachGroup Art Unit  
2814

Applicant(s): Terry L. Gilton and Dinesh Chopra

Invention: METHOD OF FORMING A METAL SEED LAYER FOR SUBSEQUENT PLATING

**TO THE ASSISTANT COMMISSIONER FOR PATENTS**

Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

**RECEIVED**  
**SEP 05 2000**  
TECHNOLOGY CENTER 2800**CLAIMS AS AMENDED**

	Claims Remaining After Amendment	Highest # Previously Paid	# Extra Claims Present	Rate	Additional Fe
<b>Total Claims</b>	45	- 115 =	0	x \$18.00	
<b>Independent Claims</b>	2	- 6 =	0	x \$78.00	
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					
Other fee (please specify):					
<b>TOTAL ADDITIONAL FEE FOR THIS AMENDMENT</b>					

☒ Large Entity☐ Small Entity☒ No additional fee is required for amendment.☐ Please charge Deposit Account No. 4 - 1073 in the amount of \_\_\_\_\_  
A duplicate copy of this sheet is enclosed.☐ A check in the amount of \_\_\_\_\_ to cover the filing fee is enclosed.☒ The Commissioner is hereby authorized to charge and credit Deposit Account No. 4 - 1073 as described below. A duplicate copy of this sheet is enclosed.☒ Credit any overpayment.☒ Charge any additional filing or application processing fees required under 37 C.F.R. 1.16 and 1.17.
  
 \_\_\_\_\_  
 Thomas J. D'Amico

Dated: August 31, 2000

Attorney Reg. No.: 28,371

**DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP**

2101 L Street NW

Washington, DC 20037-1526

(202) 785-9700